

## Features

- EE Programmable 65,536 x 1-, 131,072 x 1-, 262,144 x 1-, 524,288 x 1-, 1,048,576 x 1-, 2,097,152 x 1-, and 4,194,304 x 1-bit Serial Memories Designed to Store Configuration Programs for Field Programmable Gate Arrays (FPGAs)
- Supports both 3.3V and 5.0V Operating Voltage Applications
- In-System Programmable (ISP) via Two-Wire Bus
- Simple Interface to SRAM FPGAs
- Compatible with Atmel AT6000, AT40K and AT94K Devices, Altera® FLEX®, APEX™ Devices, ORCA®, Xilinx® XC3000, XC4000, XC5200, Spartan®, Virtex™ FPGAs
- Cascadable Read-back to Support Additional Configurations or Higher-density Arrays
- Very Low-power CMOS EEPROM Process
- Programmable Reset Polarity
- Available in 6 mm x 6 mm x 1 mm 8-lead LAP (Pin-compatible with 8-lead SOIC/VOIC Packages), 8-lead PDIP, 8-lead SOIC, 20-lead PLCC, 20-lead SOIC, 44-lead PLCC and 44-lead TQFP Packages
- Emulation of Atmel's AT24CXXX Serial EEPROMs
- Low-power Standby Mode
- High-reliability
  - Endurance: 100,000 Write Cycles
  - Data Retention: 90 Years for Industrial Parts (at 85°C) and 190 Years for Commercial Parts (at 70°C)
- Green (Pb/Halide-free/RoHS Compliant) Package Options Available

## 1. Description

The AT17LV series FPGA Configuration EEPROMs (Configurators) provide an easy-to-use, cost-effective configuration memory for Field Programmable Gate Arrays. The AT17LV series device is packaged in the 8-lead LAP, 8-lead PDIP, 8-lead SOIC, 20-lead PLCC, 20-lead SOIC, 44-lead PLCC and 44-lead TQFP, see [Table 1-1](#). The AT17LV series Configurators uses a simple serial-access procedure to configure one or more FPGA devices. The user can select the polarity of the reset function by programming four EEPROM bytes. These devices also support a write-protection mechanism within its programming mode.

The AT17LV series configurators can be programmed with industry-standard programmers, Atmel's ATDH2200E Programming Kit or Atmel's ATDH2225 ISP Cable.



## FPGA Configuration EEPROM Memory

**AT17LV65**  
**AT17LV128**  
**AT17LV256**  
**AT17LV512**  
**AT17LV010**  
**AT17LV002**  
**AT17LV040**

## 3.3V and 5V System Support



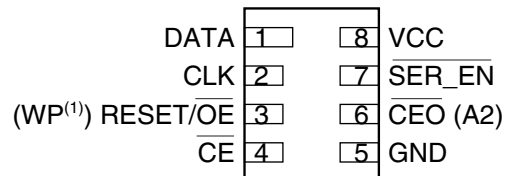
**Table 1-1.** AT17LV Series Packages

| Package      | AT17LV65/<br>AT17LV128/<br>AT17LV256 | AT17LV512/<br>AT17LV010          | AT17LV002                        | AT17LV040 |
|--------------|--------------------------------------|----------------------------------|----------------------------------|-----------|
| 8-lead LAP   | Yes                                  | Yes                              | Yes                              | (3)       |
| 8-lead PDIP  | Yes                                  | Yes                              | —                                | —         |
| 8-lead SOIC  | Yes                                  | Use 8-lead<br>LAP <sup>(1)</sup> | Use 8-lead<br>LAP <sup>(1)</sup> | (3)       |
| 20-lead PLCC | Yes                                  | Yes                              | Yes                              | —         |
| 20-lead SOIC | Yes <sup>(2)</sup>                   | Yes <sup>(2)</sup>               | Yes <sup>(2)</sup>               | —         |
| 44-lead PLCC | —                                    | —                                | Yes                              | Yes       |
| 44-lead TQFP | —                                    | —                                | Yes                              | Yes       |

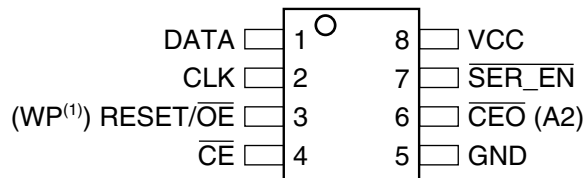
- Notes:
1. The 8-lead LAP package has the same footprint as the 8-lead SOIC. Since an 8-lead SOIC package is not available for the AT17LV512/010/002 devices, it is possible to use an 8-lead LAP package instead.
  2. The pinout for the AT17LV65/128/256 devices is not pin-for-pin compatible with the AT17LV512/010/002 devices.
  3. Refer to the AT17Fxxx datasheet, available on the Atmel web site.

## 2. Pin Configuration

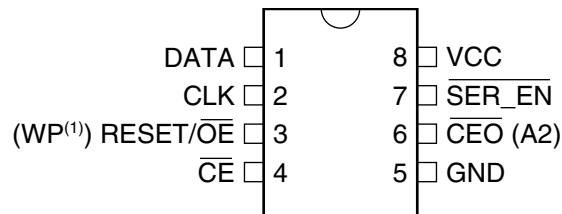
**Figure 2-1.** 8-lead LAP



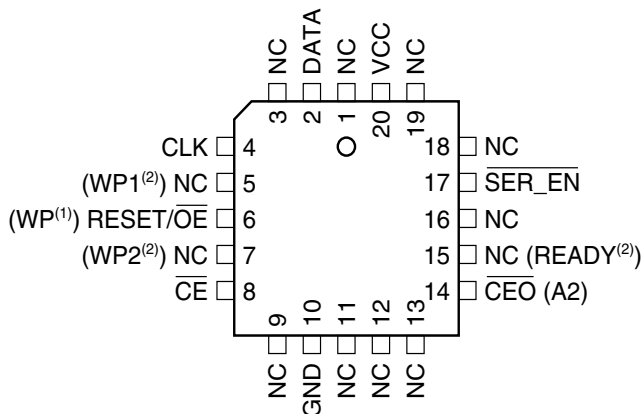
**Figure 2-2.** 8-lead SOIC



**Figure 2-3.** 8-lead PDIP

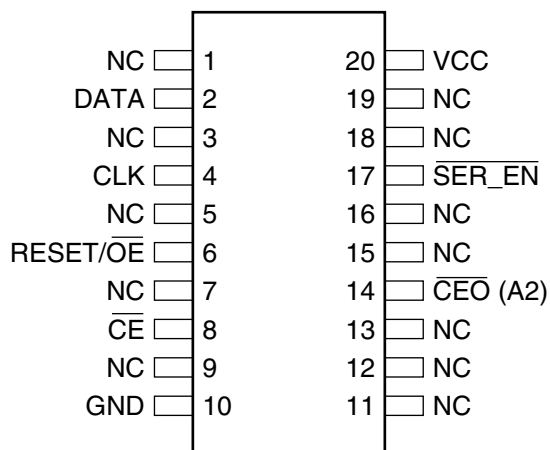


**Figure 2-4.** 20-lead PLCC



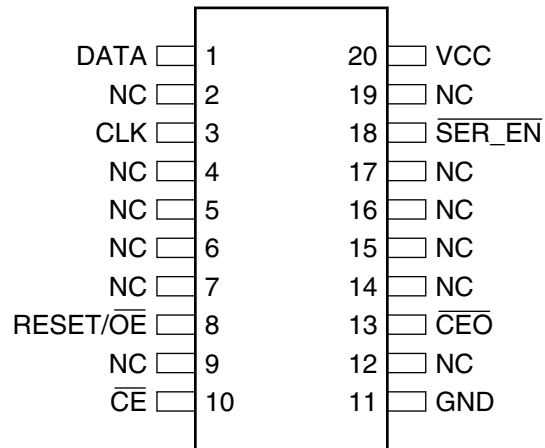
- Notes:
1. This pin is only available on AT17LV65/128/256 devices.
  2. This pin is only available on AT17LV512/010/002 devices.
  3. The CEO feature is not available on the AT17LV65 device.

**Figure 2-5.** 20-lead SOIC<sup>(1)</sup>



- Note:
1. This pinout only applies to AT17LV65/128/256 devices.

**Figure 2-6.** 20-lead SOIC<sup>(1)</sup>



Notes: 1. This pinout only applies to AT17LV512/010/002 devices.  
2. The  $\overline{\text{CEO}}$  feature is not available on the AT17LV65 device.

**Figure 2-7.** 44 PLCC

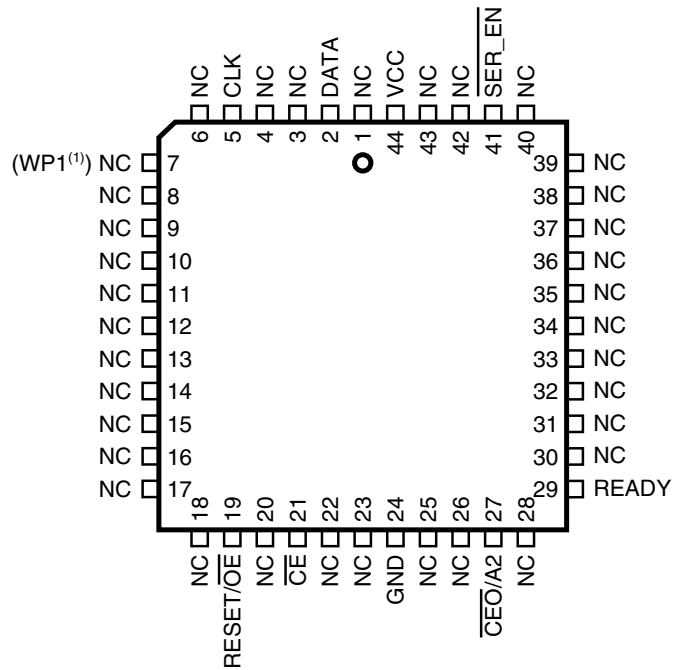
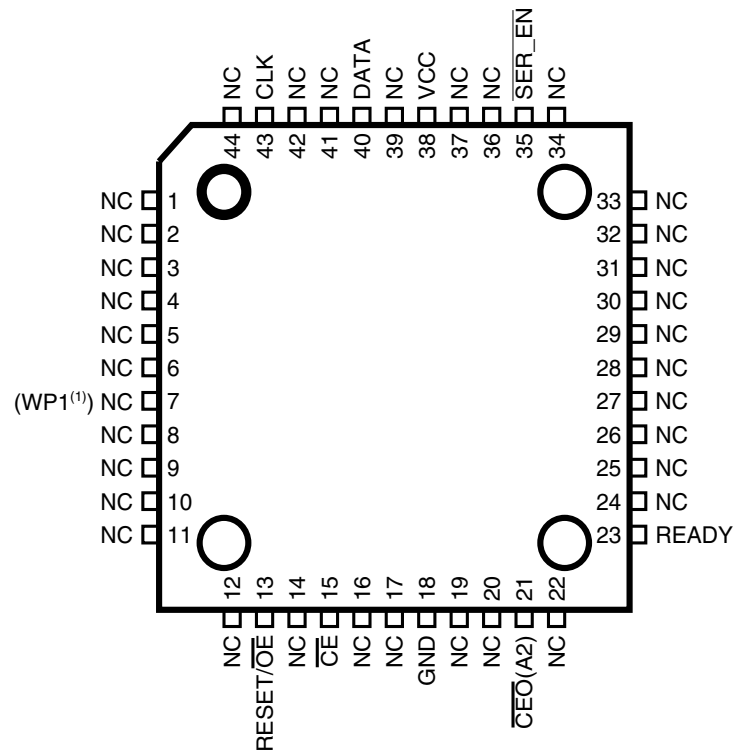
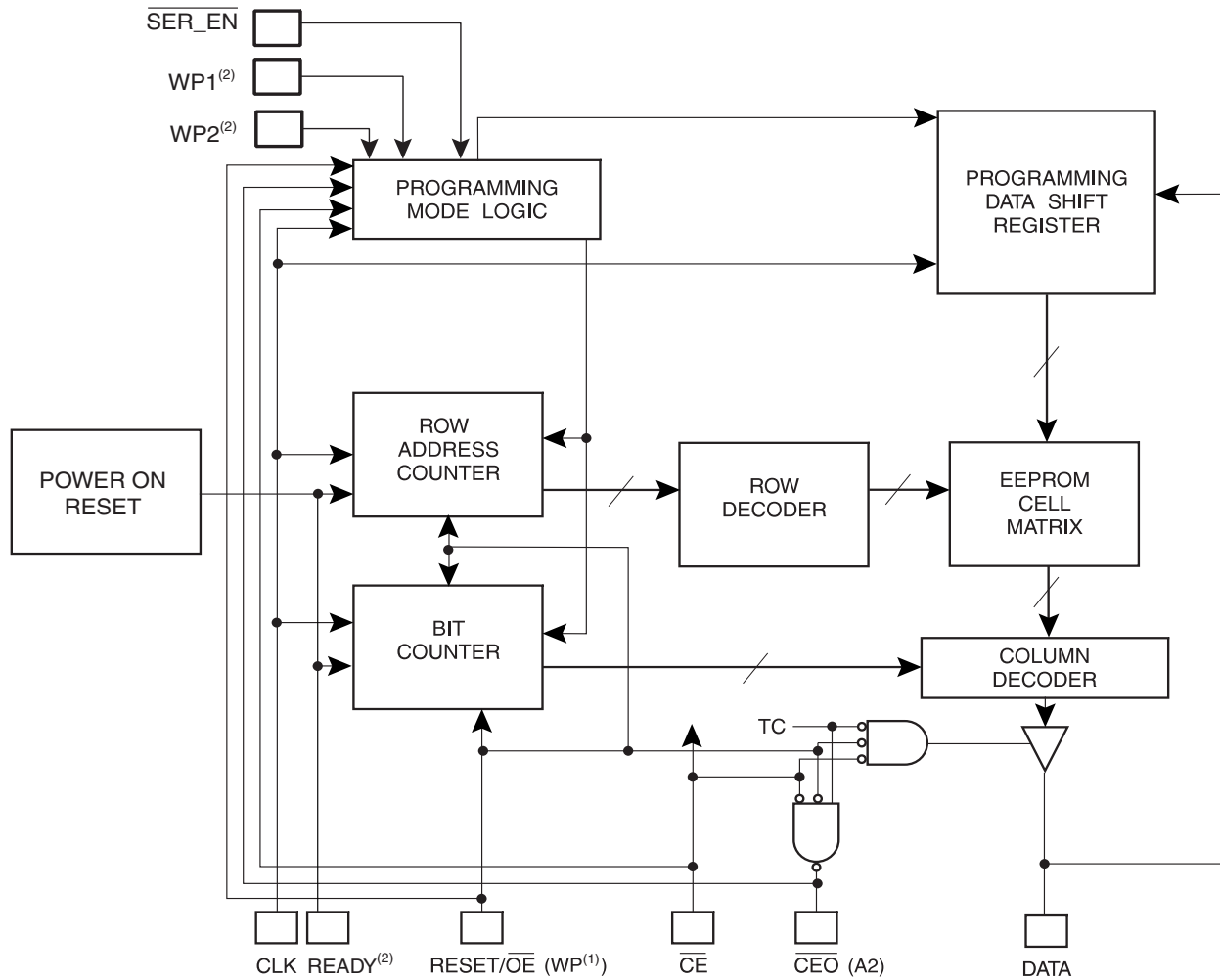


Figure 2-8. 44 TQFP



Note: 1. This pin is only available on AT17LV002 devices.

**Figure 2-9. Block Diagram**



- Notes:
1. This pin is only available on AT17LV65/128/256 devices.
  2. This pin is only available on AT17LV512/010/002 devices.
  3. The  $\overline{\text{CEO}}$  feature is not available on the AT17LV65 device.

### 3. Device Description

The control signals for the configuration EEPROM ( $\overline{CE}$ , RESET/ $\overline{OE}$  and CCLK) interface directly with the FPGA device control signals. All FPGA devices can control the entire configuration process and retrieve data from the configuration EEPROM without requiring an external intelligent controller.

The configuration EEPROM RESET/ $\overline{OE}$  and  $\overline{CE}$  pins control the tri-state buffer on the DATA output pin and enable the address counter. When RESET/ $\overline{OE}$  is driven High, the configuration EEPROM resets its address counter and tri-states its DATA pin. The  $\overline{CE}$  pin also controls the output of the AT17LV series configurator. If  $\overline{CE}$  is held High after the RESET/ $\overline{OE}$  reset pulse, the counter is disabled and the DATA output pin is tri-stated. When  $\overline{OE}$  is subsequently driven Low, the counter and the DATA output pin are enabled. When RESET/ $\overline{OE}$  is driven High again, the address counter is reset and the DATA output pin is tri-stated, regardless of the state of  $\overline{CE}$ .

When the configurator has driven out all of its data and  $\overline{CEO}$  is driven Low, the device tri-states the DATA pin to avoid contention with other configurators. Upon power-up, the address counter is automatically reset.

This is the default setting for the device. Since almost all FPGAs use RESET Low and OE High, this document will describe  $\overline{RESET/OE}$ .

### 4. Pin Description

| Name                   | I/O | AT17LV65/<br>AT17LV128/<br>AT17LV256 |            |            | AT17LV512/<br>AT17LV010 |            |            | AT17LV002                 |            |            |            |            | AT17LV040  |            |
|------------------------|-----|--------------------------------------|------------|------------|-------------------------|------------|------------|---------------------------|------------|------------|------------|------------|------------|------------|
|                        |     | 8<br>DIP/<br>LAP/<br>SOIC            | 20<br>PLCC | 20<br>SOIC | 8<br>DIP/<br>LAP        | 20<br>PLCC | 20<br>SOIC | 8<br>DIP/<br>LAP/<br>SOIC | 20<br>PLCC | 20<br>SOIC | 44<br>PLCC | 44<br>TQFP | 44<br>PLCC | 44<br>TQFP |
| DATA                   | I/O | 1                                    | 2          | 2          | 1                       | 2          | 1          | 1                         | 2          | 1          | 2          | 40         | 2          | 40         |
| CLK                    | I   | 2                                    | 4          | 4          | 2                       | 4          | 3          | 2                         | 4          | 3          | 5          | 43         | 5          | 43         |
| WP1                    | I   | –                                    | –          | –          | –                       | 5          | –          | –                         | 5          | –          | –          | –          | –          | –          |
| RESET/ $\overline{OE}$ | I   | 3                                    | 6          | 6          | 3                       | 6          | 8          | 3                         | 6          | 8          | 19         | 13         | 19         | 13         |
| WP2                    | I   |                                      |            |            | –                       | 7          | –          | –                         | 7          | –          | –          | –          | –          | –          |
| $\overline{CE}$        | I   | 4                                    | 8          | 8          | 4                       | 8          | 10         | 4                         | 8          | 10         | 21         | 15         | 21         | 15         |
| GND                    |     | 5                                    | 10         | 10         | 5                       | 10         | 11         | 5                         | 10         | 11         | 24         | 18         | 24         | 18         |
| $\overline{CEO}$       | O   | 6                                    | 14         | 14         | 6                       | 14         | 13         | 6                         | 14         | 13         | 27         | 21         | 27         | 21         |
| A2                     | I   |                                      |            |            |                         |            | –          |                           |            | –          |            |            |            |            |
| READY                  | O   | –                                    | –          | –          | –                       | 15         | –          | –                         | 15         | –          | 29         | 23         | 29         | 23         |
| SER_EN                 | I   | 7                                    | 17         | 17         | 7                       | 17         | 18         | 7                         | 17         | 18         | 41         | 35         | 41         | 35         |
| V <sub>CC</sub>        |     | 8                                    | 20         | 20         | 8                       | 20         | 20         | 8                         | 20         | 20         | 44         | 38         | 44         | 38         |

Note: 1. The  $\overline{CEO}$  feature is not available on the AT17LV65 device.



#### 4.1 DATA

Three-state DATA output for configuration. Open-collector bi-directional pin for programming.

#### 4.2 CLK

Clock input. Used to increment the internal address and bit counter for reading and programming.

#### 4.3 WP1

WRITE PROTECT (1). Used to protect portions of memory during programming. Disabled by default due to internal pull-down resistor. This input pin is not used during FPGA loading operations. This pin is only available on AT17LV512/010/002 devices.

#### 4.4 RESET/ $\overline{\text{OE}}$

Output Enable (active High) and RESET (active Low) when  $\overline{\text{SER\_EN}}$  is High. A Low level on  $\overline{\text{RESET/OE}}$  resets both the address and bit counters. A High level (with  $\overline{\text{CE}}$  Low) enables the data output driver. The logic polarity of this input is programmable as either RESET/ $\overline{\text{OE}}$  or  $\overline{\text{RESET/OE}}$ . For most applications, RESET should be programmed active Low. This document describes the pin as RESET/ $\overline{\text{OE}}$ .

#### 4.5 WP

Write protect (WP) input (when  $\overline{\text{CE}}$  is Low) during programming only ( $\overline{\text{SER\_EN}}$  Low). When WP is Low, the entire memory can be written. When WP is enabled (High), the lowest block of the memory cannot be written. This pin is only available on AT17LV65/128/256 devices.

#### 4.6 WP2

WRITE PROTECT (2). Used to protect portions of memory during programming. Disabled by default due to internal pull-down resistor. This input pin is not used during FPGA loading operations. This pin is only available on AT17LV512/010 devices.

#### 4.7 $\overline{\text{CE}}$

Chip Enable input (active Low). A Low level (with OE High) allows CLK to increment the address counter and enables the data output driver. A High level on  $\overline{\text{CE}}$  disables both the address and bit counters and forces the device into a low-power standby mode. Note that this pin will *not* enable/disable the device in the Two-Wire Serial Programming mode ( $\overline{\text{SER\_EN}}$  Low).

#### 4.8 GND

Ground pin. A 0.2  $\mu\text{F}$  decoupling capacitor between  $V_{\text{CC}}$  and GND is recommended.

#### 4.9 CEO

Chip Enable Output (active Low). This output goes Low when the address counter has reached its maximum value. In a daisy chain of AT17LV series devices, the  $\overline{\text{CEO}}$  pin of one device must be connected to the  $\overline{\text{CE}}$  input of the next device in the chain. It will stay Low as long as  $\overline{\text{CE}}$  is Low and OE is High. It will then follow CE until OE goes Low; thereafter,  $\overline{\text{CEO}}$  will stay High until the entire EEPROM is read again. This  $\overline{\text{CEO}}$  feature is not available on the AT17LV65 device.



#### **4.10 A2**

Device selection input, A2. This is used to enable (or select) the device during programming (i.e., when  $\overline{\text{SER\_EN}}$  is Low). A2 has an internal pull-down resistor.

#### **4.11 READY**

Open collector reset state indicator. Driven Low during power-up reset, released when power-up is complete. It is recommended to use a 4.7 k $\Omega$  pull-up resistor when this pin is used.

#### **4.12 $\overline{\text{SER\_EN}}$**

Serial enable must be held High during FPGA loading operations. Bringing  $\overline{\text{SER\_EN}}$  Low enables the Two-Wire Serial Programming Mode. For non-ISP applications,  $\overline{\text{SER\_EN}}$  should be tied to  $V_{CC}$ .

#### **4.13 $V_{CC}$**

3.3V ( $\pm 10\%$ ) and 5.0V ( $\pm 5\%$  Commercial,  $\pm 10\%$  Industrial) power supply pin.

### **5. FPGA Master Serial Mode Summary**

The I/O and logic functions of any SRAM-based FPGA are established by a configuration program. The program is loaded either automatically upon power-up, or on command, depending on the state of the FPGA mode pins. In Master mode, the FPGA automatically loads the configuration program from an external memory. The AT17LV Serial Configuration EEPROM has been designed for compatibility with the Master Serial mode.

This document discusses the Atmel AT40K, AT40KAL and AT94KAL applications as well as Xilinx applications.

### **6. Control of Configuration**

Most connections between the FPGA device and the AT17LV Serial EEPROM are simple and self-explanatory.

- The DATA output of the AT17LV series configurator drives DIN of the FPGA devices.
- The master FPGA CCLK output drives the CLK input of the AT17LV series configurator.
- The  $\overline{\text{CEO}}$  output of any AT17LV series configurator drives the  $\overline{\text{CE}}$  input of the next configurator in a cascaded chain of EEPROMs.
- $\overline{\text{SER\_EN}}$  must be connected to  $V_{CC}$  (except during ISP).
- The READY<sup>(1)</sup> pin is available as an open-collector indicator of the device's reset status; it is driven Low while the device is in its power-on reset cycle and released (tri-stated) when the cycle is complete.

Note: 1. This pin is not available for the AT17LV65/128/256 devices.

## 7. Cascading Serial Configuration EEPROMs

For multiple FPGAs configured as a daisy-chain, or for FPGAs requiring larger configuration memories, cascaded configurators provide additional memory.

After the last bit from the first configurator is read, the clock signal to the configurator asserts its  $\overline{CEO}$  output Low and disables its DATA line driver. The second configurator recognizes the Low level on its  $\overline{CE}$  input and enables its DATA output.

After configuration is complete, the address counters of all cascaded configurators are reset if the  $\overline{RESET/OE}$  on each configurator is driven to its active (Low) level.

If the address counters are not to be reset upon completion, then the  $\overline{RESET/OE}$  input can be tied to its inactive (High) level.

The AT17LV65 devices do not have the  $\overline{CEO}$  feature to perform cascaded configurations.

## 8. AT17LV Series Reset Polarity

The AT17LV series configurator allows the user to program the reset polarity as either  $\overline{RESET/OE}$  or  $\overline{RESET}/OE$ . This feature is supported by industry-standard programmer algorithms.

## 9. Programming Mode

The programming mode is entered by bringing  $\overline{SER\_EN}$  Low. In this mode the chip can be programmed by the Two-Wire serial bus. The programming is done at  $V_{CC}$  supply only. Programming super voltages are generated inside the chip.

## 10. Standby Mode

The AT17LV series configurators enter a low-power standby mode whenever  $\overline{CE}$  is asserted High. In this mode, the AT17LV65/128/256 configurator consumes less than 50  $\mu A$  of current at 3.3V (100  $\mu A$  for the AT17LV512/010 and 200  $\mu A$  for the AT17LV002/040). The output remains in a high-impedance state regardless of the state of the  $\overline{OE}$  input.

## 11. Absolute Maximum Ratings\*

|                                                    |                          |
|----------------------------------------------------|--------------------------|
| Operating Temperature .....                        | -40°C to +85°C           |
| Storage Temperature .....                          | -65°C to +150°C          |
| Voltage on Any Pin<br>with Respect to Ground ..... | -0.1V to $V_{CC} + 0.5V$ |
| Supply Voltage ( $V_{CC}$ ) .....                  | -0.5V to +7.0V           |
| Maximum Soldering Temp. (10 sec. @ 1/16 in.) ..... | 260°C                    |
| ESD ( $R_{ZAP} = 1.5K$ , $C_{ZAP} = 100$ pF) ..... | 2000V                    |

\*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those listed under operating conditions is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

## 12. Operating Conditions

| Symbol   | Description |                                                  | 3.3V |     | 5V   |      | Units |
|----------|-------------|--------------------------------------------------|------|-----|------|------|-------|
|          |             |                                                  | Min  | Max | Min  | Max  |       |
| $V_{CC}$ | Commercial  | Supply voltage relative to GND<br>-0°C to +70°C  | 3.0  | 3.6 | 4.75 | 5.25 | V     |
|          | Industrial  | Supply voltage relative to GND<br>-40°C to +85°C | 3.0  | 3.6 | 4.5  | 5.5  | V     |

### 13. DC Characteristics

$V_{CC} = 3.3V \pm 10\%$

| Symbol    | Description                                                 | AT17LV65/<br>AT17LV128/<br>AT17LV256 |          | AT17LV512/<br>AT17LV010 |          | AT17LV002/<br>AT17LV040 |          | Units   |
|-----------|-------------------------------------------------------------|--------------------------------------|----------|-------------------------|----------|-------------------------|----------|---------|
|           |                                                             | Min                                  | Max      | Min                     | Max      | Min                     | Max      |         |
| $V_{IH}$  | High-level Input Voltage                                    | 2.0                                  | $V_{CC}$ | 2.0                     | $V_{CC}$ | 2.0                     | $V_{CC}$ | V       |
| $V_{IL}$  | Low-level Input Voltage                                     | 0                                    | 0.8      | 0                       | 0.8      | 0                       | 0.8      | V       |
| $V_{OH}$  | High-level Output Voltage ( $I_{OH} = -2.5$ mA)             | 2.4                                  |          | 2.4                     |          | 2.4                     |          | V       |
| $V_{OL}$  | Low-level Output Voltage ( $I_{OL} = +3$ mA)                |                                      | 0.4      |                         | 0.4      |                         | 0.4      | V       |
| $V_{OH}$  | High-level Output Voltage ( $I_{OH} = -2$ mA)               | 2.4                                  |          | 2.4                     |          | 2.4                     |          | V       |
| $V_{OL}$  | Low-level Output Voltage ( $I_{OL} = +3$ mA)                |                                      | 0.4      |                         | 0.4      |                         | 0.4      | V       |
| $I_{CCA}$ | Supply Current, Active Mode                                 |                                      | 5        |                         | 5        |                         | 5        | mA      |
| $I_L$     | Input or Output Leakage Current ( $V_{IN} = V_{CC}$ or GND) | -10                                  | 10       | -10                     | 10       | -10                     | 10       | $\mu$ A |
| $I_{CCS}$ | Supply Current, Standby Mode                                | Commercial                           | 50       |                         | 100      |                         | 150      | $\mu$ A |
|           |                                                             | Industrial                           | 100      |                         | 100      |                         | 150      | $\mu$ A |

### 14. DC Characteristics

$V_{CC} = 5V \pm 5\%$  Commercial;  $V_{CC} = 5V \pm 10\%$  Industrial

| Symbol    | Description                                                 | AT17LV65/<br>AT17LV128/<br>AT17LV256 |          | AT17LV512/<br>AT17LV010 |          | AT17LV002/<br>AT17LV040 |          | Units   |
|-----------|-------------------------------------------------------------|--------------------------------------|----------|-------------------------|----------|-------------------------|----------|---------|
|           |                                                             | Min                                  | Max      | Min                     | Max      | Min                     | Max      |         |
| $V_{IH}$  | High-level Input Voltage                                    | 2.0                                  | $V_{CC}$ | 2.0                     | $V_{CC}$ | 2.0                     | $V_{CC}$ | V       |
| $V_{IL}$  | Low-level Input Voltage                                     | 0                                    | 0.8      | 0                       | 0.8      | 0                       | 0.8      | V       |
| $V_{OH}$  | High-level Output Voltage ( $I_{OH} = -2.5$ mA)             | 3.7                                  |          | 3.86                    |          | 3.86                    |          | V       |
| $V_{OL}$  | Low-level Output Voltage ( $I_{OL} = +3$ mA)                |                                      | 0.32     |                         | 0.32     |                         | 0.32     | V       |
| $V_{OH}$  | High-level Output Voltage ( $I_{OH} = -2$ mA)               | 3.6                                  |          | 3.76                    |          | 3.76                    |          | V       |
| $V_{OL}$  | Low-level Output Voltage ( $I_{OL} = +3$ mA)                |                                      | 0.37     |                         | 0.37     |                         | 0.37     | V       |
| $I_{CCA}$ | Supply Current, Active Mode                                 |                                      | 10       |                         | 10       |                         | 10       | mA      |
| $I_L$     | Input or Output Leakage Current ( $V_{IN} = V_{CC}$ or GND) | -10                                  | 10       | -10                     | 10       | -10                     | 10       | $\mu$ A |
| $I_{CCS}$ | Supply Current, Standby Mode                                | Commercial                           | 75       |                         | 200      |                         | 350      | $\mu$ A |
|           |                                                             | Industrial                           | 150      |                         | 200      |                         | 350      | $\mu$ A |



## 17. AC Characteristics

$V_{CC} = 3.3V \pm 10\%$

| Symbol                          | Description                                                          | AT17LV65/128/256 |     |            |     | AT17LV512/010/002/040 |     |            |     | Units |
|---------------------------------|----------------------------------------------------------------------|------------------|-----|------------|-----|-----------------------|-----|------------|-----|-------|
|                                 |                                                                      | Commercial       |     | Industrial |     | Commercial            |     | Industrial |     |       |
|                                 |                                                                      | Min              | Max | Min        | Max | Min                   | Max | Min        | Max |       |
| T <sub>OE</sub> <sup>(1)</sup>  | OE to Data Delay                                                     |                  | 50  |            | 55  |                       | 50  |            | 55  | ns    |
| T <sub>CE</sub> <sup>(1)</sup>  | $\overline{CE}$ to Data Delay                                        |                  | 60  |            | 60  |                       | 55  |            | 60  | ns    |
| T <sub>CAC</sub> <sup>(1)</sup> | CLK to Data Delay                                                    |                  | 75  |            | 80  |                       | 55  |            | 60  | ns    |
| T <sub>OH</sub>                 | Data Hold from $\overline{CE}$ , OE, or CLK                          | 0                |     | 0          |     | 0                     |     | 0          |     | ns    |
| T <sub>DF</sub> <sup>(2)</sup>  | $\overline{CE}$ or OE to Data Float Delay                            |                  | 55  |            | 55  |                       | 50  |            | 50  | ns    |
| T <sub>LC</sub>                 | CLK Low Time                                                         | 25               |     | 25         |     | 25                    |     | 25         |     | ns    |
| T <sub>HC</sub>                 | CLK High Time                                                        | 25               |     | 25         |     | 25                    |     | 25         |     | ns    |
| T <sub>SCE</sub>                | $\overline{CE}$ Setup Time to CLK<br>(to guarantee proper counting)  | 35               |     | 60         |     | 30                    |     | 35         |     | ns    |
| T <sub>HCE</sub>                | $\overline{CE}$ Hold Time from CLK<br>(to guarantee proper counting) | 0                |     | 0          |     | 0                     |     | 0          |     | ns    |
| T <sub>HOE</sub>                | OE High Time (guarantees counter is reset)                           | 25               |     | 25         |     | 25                    |     | 25         |     | ns    |
| F <sub>MAX</sub>                | Maximum Clock Frequency                                              |                  | 10  |            | 10  |                       | 15  |            | 10  | MHz   |

- Notes: 1. AC test lead = 50 pF.  
2. Float delays are measured with 5 pF AC loads. Transition is measured  $\pm 200$  mV from steady-state active levels.

## 18. AC Characteristics when Cascading

$V_{CC} = 3.3V \pm 10\%$

| Symbol                          | Description                                     | AT17LV65/128/256 |     |            |     | AT17LV512/010/002/040 |      |            |     | Units |
|---------------------------------|-------------------------------------------------|------------------|-----|------------|-----|-----------------------|------|------------|-----|-------|
|                                 |                                                 | Commercial       |     | Industrial |     | Commercial            |      | Industrial |     |       |
|                                 |                                                 | Min              | Max | Min        | Max | Min                   | Max  | Min        | Max |       |
| T <sub>CDF</sub> <sup>(2)</sup> | CLK to Data Float Delay                         |                  | 60  |            | 60  |                       | 50   |            | 50  | ns    |
| T <sub>OCK</sub> <sup>(1)</sup> | CLK to $\overline{CEO}$ Delay                   |                  | 55  |            | 60  |                       | 50   |            | 55  | ns    |
| T <sub>OCE</sub> <sup>(1)</sup> | $\overline{CE}$ to $\overline{CEO}$ Delay       |                  | 55  |            | 60  |                       | 35   |            | 40  | ns    |
| T <sub>OOE</sub> <sup>(1)</sup> | $\overline{RESET}/OE$ to $\overline{CEO}$ Delay |                  | 40  |            | 45  |                       | 35   |            | 35  | ns    |
| F <sub>MAX</sub>                | Maximum Clock Frequency                         |                  | 8   |            | 8   |                       | 12.5 |            | 10  | MHz   |

- Notes: 1. AC test lead = 50 pF.  
2. Float delays are measured with 5 pF AC loads. Transition is measured  $\pm 200$  mV from steady-state active levels.

## 19. AC Characteristics

$V_{CC} = 5V \pm 5\%$  Commercial;  $V_{CC} = 5V \pm 10\%$  Industrial

| Symbol                          | Description                                                       | AT17LV65/128/256 |      |            |      | AT17LV512/010/002/040 |     |            |     | Units |
|---------------------------------|-------------------------------------------------------------------|------------------|------|------------|------|-----------------------|-----|------------|-----|-------|
|                                 |                                                                   | Commercial       |      | Industrial |      | Commercial            |     | Industrial |     |       |
|                                 |                                                                   | Min              | Max  | Min        | Max  | Min                   | Max | Min        | Max |       |
| T <sub>OE</sub> <sup>(1)</sup>  | OE to Data Delay                                                  |                  | 30   |            | 35   |                       | 30  |            | 35  | ns    |
| T <sub>CE</sub> <sup>(1)</sup>  | $\overline{CE}$ to Data Delay                                     |                  | 45   |            | 45   |                       | 45  |            | 45  | ns    |
| T <sub>CAC</sub> <sup>(1)</sup> | CLK to Data Delay                                                 |                  | 50   |            | 55   |                       | 50  |            | 50  | ns    |
| T <sub>OH</sub>                 | Data Hold from $\overline{CE}$ , OE, or CLK                       | 0                |      | 0          |      | 0                     |     | 0          |     | ns    |
| T <sub>DF</sub> <sup>(2)</sup>  | $\overline{CE}$ or OE to Data Float Delay                         |                  | 50   |            | 50   |                       | 50  |            | 50  | ns    |
| T <sub>LC</sub>                 | CLK Low Time                                                      | 20               |      | 20         |      | 20                    |     | 20         |     | ns    |
| T <sub>HC</sub>                 | CLK High Time                                                     | 20               |      | 20         |      | 20                    |     | 20         |     | ns    |
| T <sub>SCE</sub>                | $\overline{CE}$ Setup Time to CLK (to guarantee proper counting)  | 35               |      | 40         |      | 20                    |     | 25         |     | ns    |
| T <sub>HCE</sub>                | $\overline{CE}$ Hold Time from CLK (to guarantee proper counting) | 0                |      | 0          |      | 0                     |     | 0          |     | ns    |
| T <sub>HOE</sub>                | OE High Time (guarantees counter is reset)                        | 20               |      | 20         |      | 20                    |     | 20         |     | ns    |
| F <sub>MAX</sub>                | Maximum Clock Frequency                                           |                  | 12.5 |            | 12.5 |                       | 15  |            | 15  | MHz   |

- Notes: 1. AC test lead = 50 pF.  
2. Float delays are measured with 5 pF AC loads. Transition is measured  $\pm 200$  mV from steady-state active levels.

## 20. AC Characteristics when Cascading

$V_{CC} = 5V \pm 5\%$  Commercial;  $V_{CC} = 5V \pm 10\%$  Industrial

| Symbol                          | Description                                     | AT17LV65/128/256 |     |            |     | AT17LV512/010/002/040 |      |            |      | Units |
|---------------------------------|-------------------------------------------------|------------------|-----|------------|-----|-----------------------|------|------------|------|-------|
|                                 |                                                 | Commercial       |     | Industrial |     | Commercial            |      | Industrial |      |       |
|                                 |                                                 | Min              | Max | Min        | Max | Min                   | Max  | Min        | Max  |       |
| T <sub>CDF</sub> <sup>(2)</sup> | CLK to Data Float Delay                         |                  | 50  |            | 50  |                       | 50   |            | 50   | ns    |
| T <sub>OCK</sub> <sup>(1)</sup> | CLK to $\overline{CEO}$ Delay                   |                  | 35  |            | 40  |                       | 35   |            | 40   | ns    |
| T <sub>OCE</sub> <sup>(1)</sup> | $\overline{CE}$ to $\overline{CEO}$ Delay       |                  | 35  |            | 35  |                       | 35   |            | 35   | ns    |
| T <sub>OOE</sub> <sup>(1)</sup> | $\overline{RESET}/OE$ to $\overline{CEO}$ Delay |                  | 30  |            | 35  |                       | 30   |            | 30   | ns    |
| F <sub>MAX</sub>                | Maximum Clock Frequency                         |                  | 10  |            | 10  |                       | 12.5 |            | 12.5 | MHz   |

- Notes: 1. AC test lead = 50 pF.  
2. Float delays are measured with 5 pF AC loads. Transition is measured  $\pm 200$  mV from steady-state active levels.

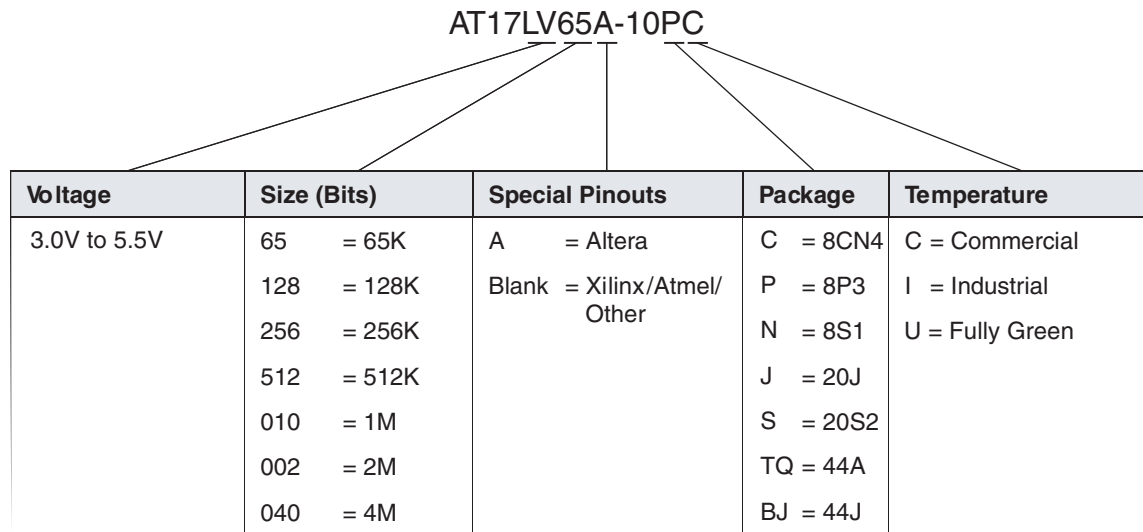
## 21. Thermal Resistance Coefficients<sup>(1)</sup>

| Package Type |                                        |                                     | AT17LV65/<br>AT17LV128/<br>AT17LV256 | AT17LV512/<br>AT17LV010 | AT17LV002 | AT17LV040 |
|--------------|----------------------------------------|-------------------------------------|--------------------------------------|-------------------------|-----------|-----------|
| 8CN<br>4     | Leadless Array Package (LAP)           | $\theta_{JC}$ [°C/W]                | 45                                   | 45                      | 45        | —         |
|              |                                        | $\theta_{JA}$ [°C/W] <sup>(2)</sup> | 115.71                               | 135.71                  | 159.60    | —         |
| 8P3          | Plastic Dual Inline Package (PDIP)     | $\theta_{JC}$ [°C/W]                | 37                                   | 37                      | —         | —         |
|              |                                        | $\theta_{JA}$ [°C/W] <sup>(2)</sup> | 107                                  | 107                     | —         | —         |
| 8S1          | Plastic Gull Wing Small Outline (SOIC) | $\theta_{JC}$ [°C/W]                | 45                                   | —                       | —         | —         |
|              |                                        | $\theta_{JA}$ [°C/W] <sup>(2)</sup> | 150                                  | —                       | —         | —         |
| 20J          | Plastic Leaded Chip Carrier (PLCC)     | $\theta_{JC}$ [°C/W]                | 35                                   | 35                      | 35        | —         |
|              |                                        | $\theta_{JA}$ [°C/W] <sup>(2)</sup> | 90                                   | 90                      | 90        | —         |
| 20S2         | Plastic Gull Wing Small Outline (SOIC) | $\theta_{JC}$ [°C/W]                |                                      |                         |           | —         |
|              |                                        | $\theta_{JA}$ [°C/W] <sup>(2)</sup> |                                      |                         |           | —         |
| 44A          | Thin Plastic Quad Flat Package (TQFP)  | $\theta_{JC}$ [°C/W]                | —                                    | —                       | 17        | 17        |
|              |                                        | $\theta_{JA}$ [°C/W] <sup>(2)</sup> | —                                    | —                       | 62        | 62        |
| 44J          | Plastic Leaded Chip Carrier (PLCC)     | $\theta_{JC}$ [°C/W]                | —                                    | —                       | 15        | 15        |
|              |                                        | $\theta_{JA}$ [°C/W] <sup>(2)</sup> | —                                    | —                       | 50        | 50        |

Notes: 1. For more information refer to the “Thermal Characteristics of Atmel’s Packages”, available on the Atmel web site.  
2. Airflow = 0 ft/min.



**Figure 21-1.** Ordering Code



| Package Type |                                                                                                          |
|--------------|----------------------------------------------------------------------------------------------------------|
| <b>8CN4</b>  | 8-lead, 6 mm x 6 mm x 1 mm, Leadless Array Package (LAP) – Pin-compatible with 8-lead SOIC/VOID Packages |
| <b>8P3</b>   | 8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)                                                  |
| <b>8S1</b>   | 8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)                                        |
| <b>20J</b>   | 20-lead, Plastic J-leaded Chip Carrier (PLCC)                                                            |
| <b>20S2</b>  | 20-lead, 0.300" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)                                       |
| <b>44A</b>   | 44-lead, Thin (1.0 mm) Plastic Quad Flat Package Carrier (TQFP)                                          |
| <b>44J</b>   | 44-lead, Plastic J-leaded Chip Carrier (PLCC)                                                            |

## 22. Ordering Information

### 22.1 Standard Package Options

| Memory Size             | Ordering Code  | Package | Operation Range               |
|-------------------------|----------------|---------|-------------------------------|
| 64-Kbit <sup>(1)</sup>  | AT17LV65-10CC  | 8CN4    | Commercial<br>(0°C to 70°C)   |
|                         | AT17LV65-10PC  | 8P3     |                               |
|                         | AT17LV65-10NC  | 8S1     |                               |
|                         | AT17LV65-10JC  | 20J     |                               |
|                         | AT17LV65-10SC  | 20S2    |                               |
|                         | AT17LV65-10CI  | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                         | AT17LV65-10PI  | 8P3     |                               |
|                         | AT17LV65-10NI  | 8S1     |                               |
|                         | AT17LV65-10JI  | 20J     |                               |
|                         | AT17LV65-10SI  | 20S2    |                               |
| 128-Kbit <sup>(1)</sup> | AT17LV128-10CC | 8CN4    | Commercial<br>(0°C to 70°C)   |
|                         | AT17LV128-10PC | 8P3     |                               |
|                         | AT17LV128-10NC | 8S1     |                               |
|                         | AT17LV128-10JC | 20J     |                               |
|                         | AT17LV128-10SC | 20S2    |                               |
|                         | AT17LV128-10CI | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                         | AT17LV128-10PI | 8P3     |                               |
|                         | AT17LV128-10NI | 8S1     |                               |
|                         | AT17LV128-10JI | 20J     |                               |
|                         | AT17LV128-10SI | 20S2    |                               |
| 256-Kbit <sup>(1)</sup> | AT17LV256-10CC | 8CN4    | Commercial<br>(0°C to 70°C)   |
|                         | AT17LV256-10PC | 8P3     |                               |
|                         | AT17LV256-10NC | 8S1     |                               |
|                         | AT17LV256-10JC | 20J     |                               |
|                         | AT17LV256-10SC | 20S2    |                               |
|                         | AT17LV256-10CI | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                         | AT17LV256-10PI | 8P3     |                               |
|                         | AT17LV256-10NI | 8S1     |                               |
|                         | AT17LV256-10JI | 20J     |                               |
|                         | AT17LV256-10SI | 20S2    |                               |
| 512-Kbit <sup>(1)</sup> | AT17LV512-10CC | 8CN4    | Commercial<br>(0°C to 70°C)   |
|                         | AT17LV512-10PC | 8P3     |                               |
|                         | AT17LV512-10JC | 20J     |                               |
|                         | AT17LV512-10SC | 20S2    |                               |
|                         | AT17LV512-10CI | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                         | AT17LV512-10PI | 8P3     |                               |
|                         | AT17LV512-10JI | 20J     |                               |
|                         | AT17LV512-10SI | 20S2    |                               |

## 22.1 Standard Package Options (Continued)

| Memory Size           | Ordering Code   | Package | Operation Range               |
|-----------------------|-----------------|---------|-------------------------------|
| 1-Mbit <sup>(1)</sup> | AT17LV010-10CC  | 8CN4    | Commercial<br>(0°C to 70°C)   |
|                       | AT17LV010-10PC  | 8P3     |                               |
|                       | AT17LV010-10JC  | 20J     |                               |
|                       | AT17LV010-10SC  | 20S2    |                               |
|                       | AT17LV010-10CI  | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                       | AT17LV010-10PI  | 8P3     |                               |
|                       | AT17LV010-10JI  | 20J     |                               |
|                       | AT17LV010-10SI  | 20S2    |                               |
| 2-Mbit <sup>(1)</sup> | AT17LV002-10CC  | 8CN4    | Commercial<br>(0°C to 70°C)   |
|                       | AT17LV002-10JC  | 20J     |                               |
|                       | AT17LV002-10SC  | 20S2    |                               |
|                       | AT17LV002-10TQC | 44A     |                               |
|                       | AT17LV002-10BJC | 44J     |                               |
|                       | AT17LV002-10CI  | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                       | AT17LV002-10JI  | 20J     |                               |
|                       | AT17LV002-10SI  | 20S2    |                               |
|                       | AT17LV002-10TQI | 44A     |                               |
|                       | AT17LV002-10BJI | 44J     |                               |
| 4-Mbit <sup>(1)</sup> | AT17LV040-10TQC | 44A     | Commercial<br>(0°C to 70°C)   |
|                       | AT17LV040-10BJC | 44J     |                               |
|                       | AT17LV040-10TQI | 44A     | Industrial<br>(-40°C to 85°C) |
|                       | AT17LV040-10BJI | 44J     |                               |

Notes: 1. For operating 5V operating voltage, please refer to the corresponding AC and DC Characteristics.

2. The last-time buy is April 11, 2006 for shaded parts.

3. For the -10CC and -10CI packages, customers may migrate to AT17LVXXX-10CU.

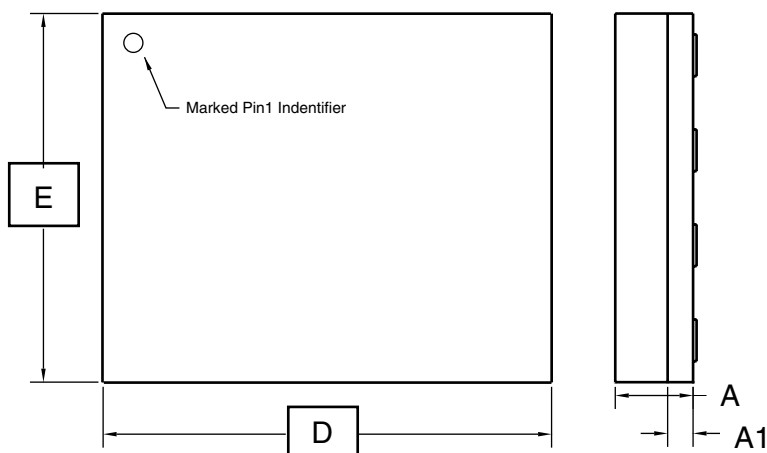
## 22.2 Green Package Options (Pb/Halide-free/RoHS Compliant)

| Memory Size             | Ordering Code   | Package | Operation Range               |
|-------------------------|-----------------|---------|-------------------------------|
| 256-Kbit <sup>(1)</sup> | AT17LV256-10CU  | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                         | AT17LV256-10JU  | 20J     |                               |
|                         | AT17LV256-10NU  | 8S1     |                               |
|                         | AT17LV256-10PU  | 8P3     |                               |
|                         | AT17LV256-10SU  | 20S2    |                               |
| 512-Kbit <sup>(1)</sup> | AT17LV512-10CU  | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                         | AT17LV512-10JU  | 20J     |                               |
| 1-Mbit <sup>(1)</sup>   | AT17LV010-10CU  | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                         | AT17LV010-10JU  | 20J     |                               |
|                         | AT17LV010-10PU  | 8P3     |                               |
| 2-Mbit <sup>(1)</sup>   | AT17LV002-10CU  | 8CN4    | Industrial<br>(-40°C to 85°C) |
|                         | AT17LV002-10JU  | 20J     |                               |
|                         | AT17LV002-10SU  | 20S2    |                               |
|                         | AT17LV002-10TQU | 44A     |                               |
| 4-Mbit <sup>(1)</sup>   | AT17LV040-10TQU | 44A     | Industrial<br>(-40°C to 85°C) |

Note: 1. For operating 5V operating voltage, please refer to the corresponding AC and DC Characteristics.

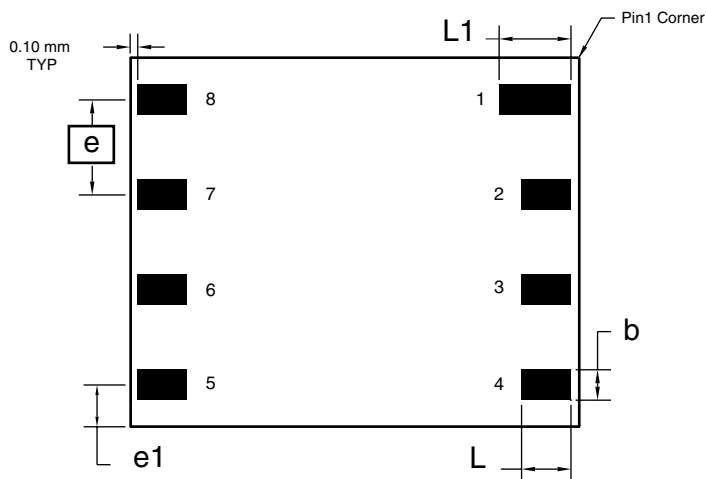
## 23. Packaging Information

### 23.1 8CN4 – LAP



Top View

Side View



Bottom View

**COMMON DIMENSIONS**  
(Unit of Measure = mm)

| SYMBOL | MIN      | NOM  | MAX  | NOTE |
|--------|----------|------|------|------|
| A      | 0.94     | 1.04 | 1.14 |      |
| A1     | 0.30     | 0.34 | 0.38 |      |
| b      | 0.45     | 0.50 | 0.55 | 1    |
| D      | 5.89     | 5.99 | 6.09 |      |
| E      | 4.89     | 5.99 | 6.09 |      |
| e      | 1.27 BSC |      |      |      |
| e1     | 1.10 REF |      |      |      |
| L      | 0.95     | 1.00 | 1.05 | 1    |
| L1     | 1.25     | 1.30 | 1.35 | 1    |

Note: 1. Metal Pad Dimensions.

11/14/01



2325 Orchard Parkway  
San Jose, CA 95131

**TITLE**

**8CN4**, 8-lead (6 x 6 x 1.04 mm Body), Lead Pitch 1.27 mm,  
Leadless Array Package (LAP)

**DRAWING NO.**

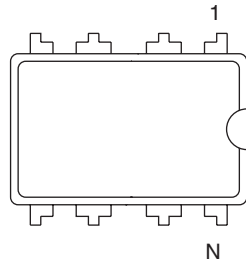
8CN4

**REV.**

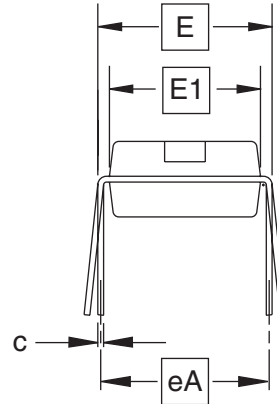
A



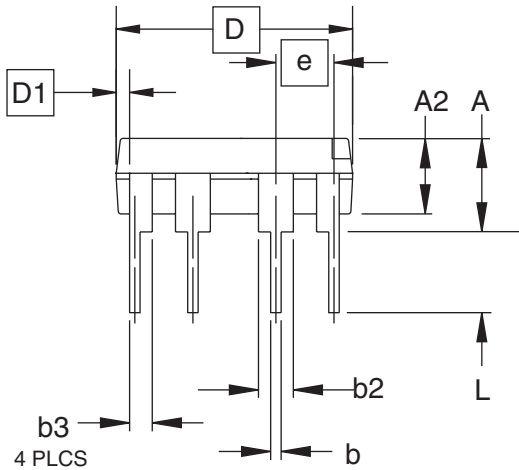
## 23.2 8P3 – PDIP



Top View



End View



Side View

**COMMON DIMENSIONS**  
(Unit of Measure = inches)

| SYMBOL | MIN       | NOM   | MAX   | NOTE |
|--------|-----------|-------|-------|------|
| A      |           |       | 0.210 | 2    |
| A2     | 0.115     | 0.130 | 0.195 |      |
| b      | 0.014     | 0.018 | 0.022 | 5    |
| b2     | 0.045     | 0.060 | 0.070 | 6    |
| b3     | 0.030     | 0.039 | 0.045 | 6    |
| c      | 0.008     | 0.010 | 0.014 |      |
| D      | 0.355     | 0.365 | 0.400 | 3    |
| D1     | 0.005     |       |       | 3    |
| E      | 0.300     | 0.310 | 0.325 | 4    |
| E1     | 0.240     | 0.250 | 0.280 | 3    |
| e      | 0.100 BSC |       |       |      |
| eA     | 0.300 BSC |       |       | 4    |
| L      | 0.115     | 0.130 | 0.150 | 2    |

- Notes:
1. This drawing is for general information only; refer to JEDEC Drawing MS-001, Variation BA for additional information.
  2. Dimensions A and L are measured with the package seated in JEDEC seating plane Gauge GS-3.
  3. D, D1 and E1 dimensions do not include mold Flash or protrusions. Mold Flash or protrusions shall not exceed 0.010 inch.
  4. E and eA measured with the leads constrained to be perpendicular to datum.
  5. Pointed or rounded lead tips are preferred to ease insertion.
  6. b2 and b3 maximum dimensions do not include Dambar protrusions. Dambar protrusions shall not exceed 0.010 (0.25 mm).

01/09/02



2325 Orchard Parkway  
San Jose, CA 95131

**TITLE**

**8P3**, 8-lead, 0.300" Wide Body, Plastic Dual  
In-line Package (PDIP)

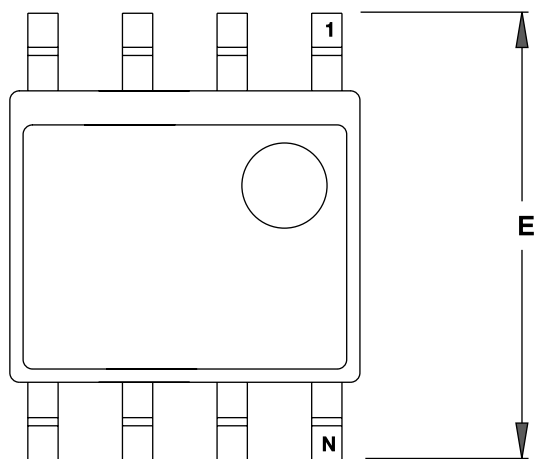
**DRAWING NO.**

8P3

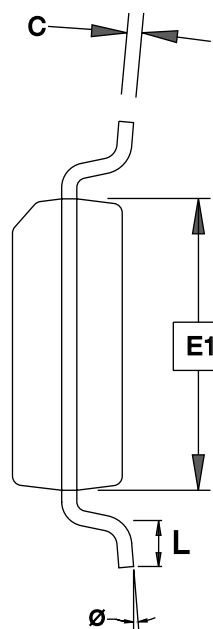
**REV.**

B

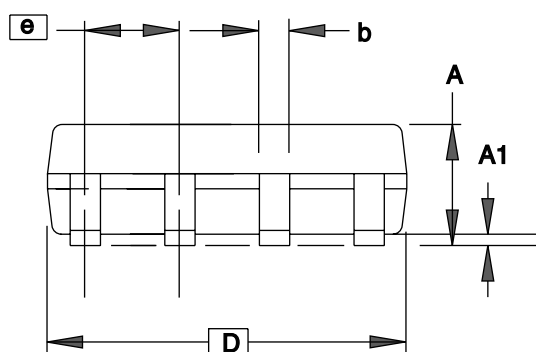
### 23.3 8S1 – SOIC



TOP VIEW



END VIEW



SIDE VIEW

COMMON DIMENSIONS  
(Unit of Measure = mm)

| SYMBOL | MIN      | NOM | MAX  | NOTE |
|--------|----------|-----|------|------|
| A      | 1.35     | –   | 1.75 |      |
| A1     | 0.10     | –   | 0.25 |      |
| b      | 0.31     | –   | 0.51 |      |
| C      | 0.17     | –   | 0.25 |      |
| D      | 4.80     | –   | 5.05 |      |
| E1     | 3.81     | –   | 3.99 |      |
| E      | 5.79     | –   | 6.20 |      |
| e      | 1.27 BSC |     |      |      |
| L      | 0.40     | –   | 1.27 |      |
| θ      | 0°       | –   | 8°   |      |

Note: These drawings are for general information only. Refer to JEDEC Drawing MS-012, Variation AA for proper dimensions, tolerances, datums, etc.

3/17/05



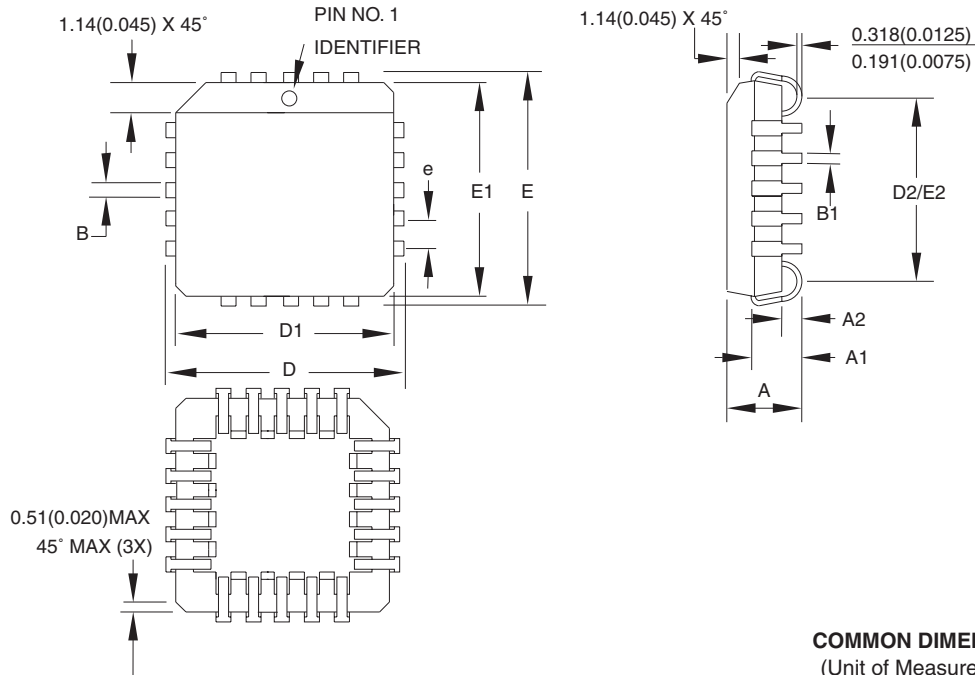
1150 E. Cheyenne Mtn. Blvd.  
Colorado Springs, CO 80906

**TITLE**  
**8S1**, 8-lead (0.150" Wide Body), Plastic Gull Wing  
Small Outline (JEDEC SOIC)

**DRAWING NO.**  
8S1

**REV.**  
C

## 23.4 20J – PLCC



**COMMON DIMENSIONS**  
(Unit of Measure = mm)

| SYMBOL | MIN       | NOM | MAX    | NOTE   |
|--------|-----------|-----|--------|--------|
| A      | 4.191     | —   | 4.572  |        |
| A1     | 2.286     | —   | 3.048  |        |
| A2     | 0.508     | —   | —      |        |
| D      | 9.779     | —   | 10.033 |        |
| D1     | 8.890     | —   | 9.042  | Note 2 |
| E      | 9.779     | —   | 10.033 |        |
| E1     | 8.890     | —   | 9.042  | Note 2 |
| D2/E2  | 7.366     | —   | 8.382  |        |
| B      | 0.660     | —   | 0.813  |        |
| B1     | 0.330     | —   | 0.533  |        |
| e      | 1.270 TYP |     |        |        |

- Notes:
1. This package conforms to JEDEC reference MS-018, Variation AA.
  2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010" (0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
  3. Lead coplanarity is 0.004" (0.102 mm) maximum.

10/04/01



2325 Orchard Parkway  
San Jose, CA 95131

### TITLE

**20J, 20-lead, Plastic J-leaded Chip Carrier (PLCC)**

### DRAWING NO.

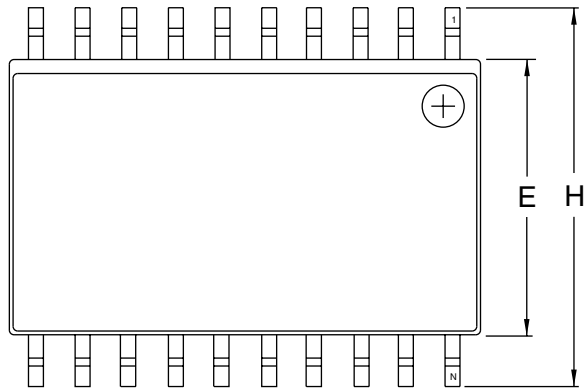
20J

### REV.

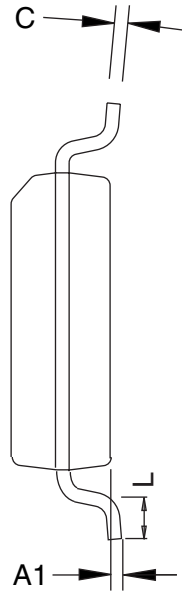
B



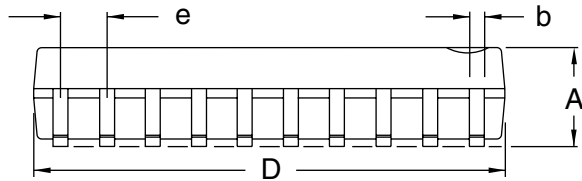
23.5 20S2 – SOIC



Top View



End View



Side View

COMMON DIMENSIONS  
(Unit of Measure = inches)

| SYMBOL | MIN       | NOM | MAX    | NOTE |
|--------|-----------|-----|--------|------|
| A      | 0.0926    |     | 0.1043 |      |
| A1     | 0.0040    |     | 0.0118 |      |
| b      | 0.0130    |     | 0.0200 | 4    |
| C      | 0.0091    |     | 0.0125 |      |
| D      | 0.4961    |     | 0.5118 | 1    |
| E      | 0.2914    |     | 0.2992 | 2    |
| H      | 0.3940    |     | 0.4190 |      |
| L      | 0.0160    |     | 0.050  | 3    |
| e      | 0.050 BSC |     |        |      |

- Notes: 1. This drawing is for general information only; refer to JEDEC Drawing MS-013, Variation AC for additional information.  
2. Dimension "D" does not include mold Flash, protrusions or gate burrs. Mold Flash, protrusions and gate burrs shall not exceed 0.15 mm (0.006") per side.  
3. Dimension "E" does not include inter-lead Flash or protrusion. Inter-lead Flash and protrusions shall not exceed 0.25 mm (0.010") per side.  
4. "L" is the length of the terminal for soldering to a substrate.  
5. The lead width "b", as measured 0.36 mm (0.014") or greater above the seating plane, shall not exceed a maximum value of 0.61 mm (0.024") per side.



2325 Orchard Parkway  
San Jose, CA 95131

TITLE

20S2, 20-lead, 0.300" Wide Body, Plastic Gull  
Wing Small Outline Package (SOIC)

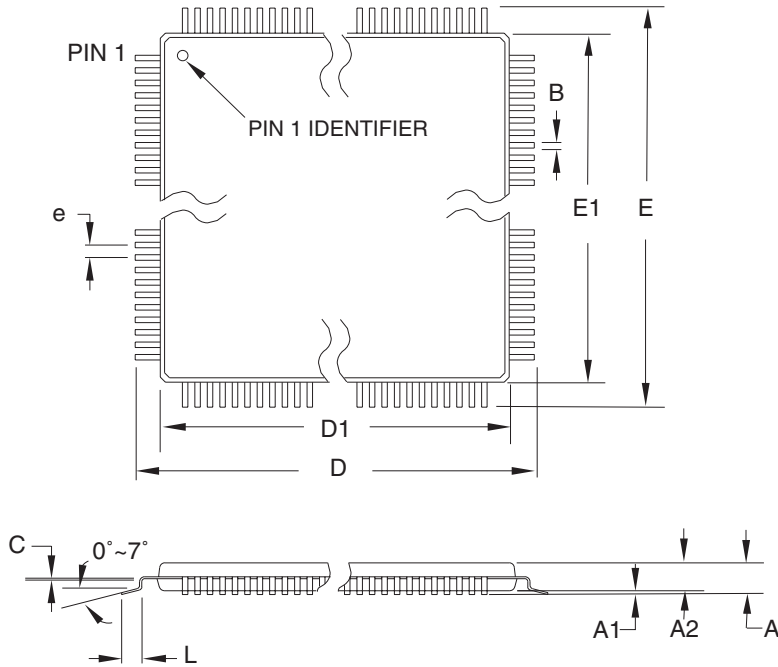
DRAWING NO.

20S2

REV.

A

## 23.6 44A – TQFP



**COMMON DIMENSIONS**  
(Unit of Measure = mm)

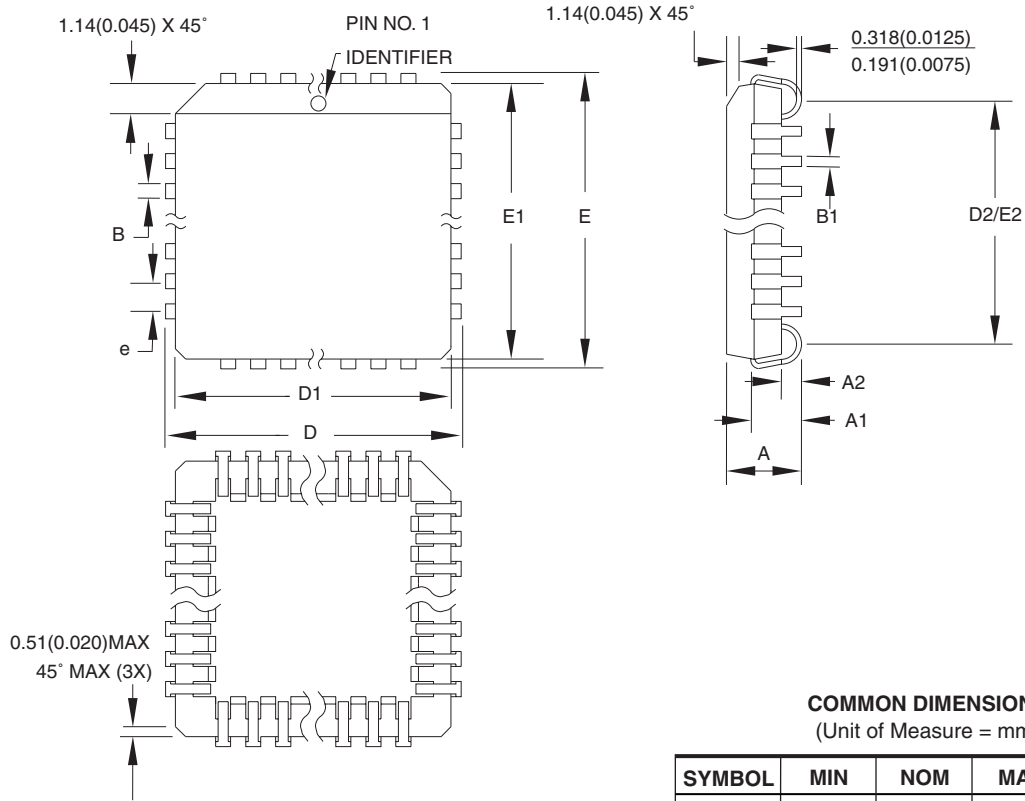
| SYMBOL | MIN      | NOM   | MAX   | NOTE   |
|--------|----------|-------|-------|--------|
| A      | –        | –     | 1.20  |        |
| A1     | 0.05     | –     | 0.15  |        |
| A2     | 0.95     | 1.00  | 1.05  |        |
| D      | 11.75    | 12.00 | 12.25 |        |
| D1     | 9.90     | 10.00 | 10.10 | Note 2 |
| E      | 11.75    | 12.00 | 12.25 |        |
| E1     | 9.90     | 10.00 | 10.10 | Note 2 |
| B      | 0.30     | –     | 0.45  |        |
| C      | 0.09     | –     | 0.20  |        |
| L      | 0.45     | –     | 0.75  |        |
| e      | 0.80 TYP |       |       |        |

- Notes:
1. This package conforms to JEDEC reference MS-026, Variation ACB.
  2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25 mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
  3. Lead coplanarity is 0.10 mm maximum.

10/5/2001

|                                                                                                                                |                                                                                                                                                        |                           |                  |
|--------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------|------------------|
|  2325 Orchard Parkway<br>San Jose, CA 95131 | <b>TITLE</b><br><b>44A</b> , 44-lead, 10 x 10 mm Body Size, 1.0 mm Body Thickness,<br>0.8 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP) | <b>DRAWING NO.</b><br>44A | <b>REV.</b><br>B |
|--------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------|------------------|

### 23.7 44J – PLCC



**COMMON DIMENSIONS**  
(Unit of Measure = mm)

| SYMBOL | MIN       | NOM | MAX    | NOTE   |
|--------|-----------|-----|--------|--------|
| A      | 4.191     | –   | 4.572  |        |
| A1     | 2.286     | –   | 3.048  |        |
| A2     | 0.508     | –   | –      |        |
| D      | 17.399    | –   | 17.653 |        |
| D1     | 16.510    | –   | 16.662 | Note 2 |
| E      | 17.399    | –   | 17.653 |        |
| E1     | 16.510    | –   | 16.662 | Note 2 |
| D2/E2  | 14.986    | –   | 16.002 |        |
| B      | 0.660     | –   | 0.813  |        |
| B1     | 0.330     | –   | 0.533  |        |
| e      | 1.270 TYP |     |        |        |

- Notes:
1. This package conforms to JEDEC reference MS-018, Variation AC.
  2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010" (0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
  3. Lead coplanarity is 0.004" (0.102 mm) maximum.

10/04/01



2325 Orchard Parkway  
San Jose, CA 95131

**TITLE**

**44J, 44-lead, Plastic J-leaded Chip Carrier (PLCC)**

**DRAWING NO.**

44J

**REV.**

B





## 24. Revision History

| Revision Level – Release Date | History                                                    |
|-------------------------------|------------------------------------------------------------|
| H – March 2006                | Added last-time buy for AT17LVXXX-10CC and AT17LVXXX-10CI. |



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